Supporting Material

DNA Chip (Immobilization of MFPs on Slides, bottom surface)

DNA oligomers 1, 2, and 3 were purchased HPLC grade from IBA GmbH (Goettingen, Germany). Sequences and modifications of all oligonucleotides are the following: shear geometry: 1_s, NH₂-(HEGL)₅-5'-(T)₁₀-CTG CAG GAA TTC GAT ATC AAG CTT ATC GAT-3'; 2_s, 3'-GAC GTC CTT AAG CTA TAG TTC GAA TAG CTA C-(T)7-5'-5'-T(Cy5)-(T)7-C GAC GTC CTT AAG CTA TAG TTC GAA TAG CTA-3'; 3_s, biotin-5'-(T)₁₀-TAG CTA TTC GAA CTA TAG CTT AAG GAC GTC(Cy3)-3'. Zipper geometry: 1z, 5'-CTG CAG GAA TTC GAT ATC AAG CTT ATC GAT-(T)10-(HEGL)5-NH2-3'; 2Z, 5'-GAC GTC CTT AAG CTA TAG TTC GAA TAG CTA C-(T)7-T(Cy5)-(T)8-C ATC GAT AAG CTT GAT ATC GAA TTC CTG CAG-3'; 3z, biotin-5'-(T)₁₀-TAG CTA TTC GAA CTA TAG CTT AAG GAC GTC(Cy3)-3'. The five hexaethyleneglycol (HEGL) linkers are connected via phosphate groups. DNA oligomer 1 is amine-modified, which allows covalent linkage to aldehyde-functionalized glass slides (Schott GmbH, Jena, Germany). We spotted 1 µL drops of 5× SSC (saline sodium citrate; Sigma-Aldrich GmbH, Munich, Germany) containing 25 μ M oligomer 1 on the aldehyde slide in a 4 × 4 pattern and incubated the slide in a saturated NaCl ddH₂O atmosphere overnight. After washing the slide with ddH₂O containing 0.2% sodium dodecyl sulfate (SDS; VWR Scientific GmbH, Darmstadt, Germany) and thoroughly rinsing the slide with ddH₂O we reduced the resulting Schiff bases with 1% aqueous NaBH₄ (VWR Scientific GmbH, Darmstadt, Germany) for 90 min. Subsequently, the slide was washed with 1× SSC and thoroughly rinsed with ddH₂O. In order to reduce nonspecific binding, the slides were blocked in 1× SSC containing 4% bovine serum albumin (BSA; Sigma-Aldrich GmbH, Munich, Germany) for 20 min. Custom-made 16-well silicone isolators (Grace-Biolabs, OR) were placed on top of the immobilized DNA oligomer 1. The 100 nM Cy5-modified oligomer 2 and 200 nM biotinmodified oligomer 3 were hybridized to the latter for 30 min, completing the $1 \cdot 2 \cdot 3$ complex on the glass slide. After removing the silicone isolators the slides were washed with a self-made fluidic system driven by a multi-channel peristaltic pump (Ismatec GmbH, Wertheim-Mondfeld, Germany) to remove any unspecific bound DNA oligomers. The 4×4 pattern was rinsed subsequently with 2× SSC, 0.2× SSC containing 0.1% Tween 20 (VWR Scientific GmbH, Darmstadt, Germany) and $1 \times PBS$ each with 50 ml in 5 min.

PDMS stamp (Top Surface)

The stamp is made of polydimethylsiloxane (PDMS) and is fabricated as detailed previously with some modifications.¹ PDMS stamps are fabricated by casting 10:1 (base/crosslinker) (Sylgard, Dow Corning, MI) into a custom-made micro- and millistructured silicon wafer (HSG-IMIT, Villingen-Schwenningen, Germany).² After curing was complete, the PDMS was taken out of the mold and cut into a 4 × 4 pillar arrangement. Each pillar is 1 mm diameter, is 1 mm high, and carries a microstructure on the flat surface: 100 mm × 100 mm pads are separated by 41 mm wide and 5 mm deep trenches allowing for liquid drainage during the contact and separation process. Free polymers were extracted in toluene for at least one day.³ The PDMS was activated overnight in 12.5% hydrochloric acid and subsequently derivatized with (3-glycidoxypropyl)-trimethoxysilane (ABCR, Karlsruhe, Germany) was melted at 80°C, and ~1 mL was spotted on each pillar followed by overnight incubation in argon atmosphere at 80°C. The excess polymers were thoroughly removed with ddH₂O. Shortly before the experiment, the PDMS was incubated with 1 mg/mL streptavidin (Thermo Fisher Scientific, Bonn, Germany) in 1× PBS and 0.4% bovine serum albumin for 60 min, washed with 1× PBS containing 0.1% Tween 20, with 1× PBS and gently dried with N₂ gas.

References

- D. Ho, C. Dose, C. H. Albrecht, P. Severin, K. Falter, P. B. Dervan and H. E. Gaub, *Biophys J*, 2009, 96, 4661-4671.
- C. H. Albrecht, H. Clausen-Schaumann and H. E. Gaub, *Journal of Physics: Condensed Matter*, 2006, 18, 581-599.
- 3. S. Perutz, E. Kramer, J. Baney and C. Hui, *Macromolecules*, 1997, **30**, 7964-7969.